FEATURES<br>80 MSPS Sample Rate<br>80 dBFS Signal-to-Noise Ratio<br>Transformer Coupled Analog Input<br>Single PECL Clock Source<br>Digital Outputs<br>True Binary Format<br>3.3 V and 5 V CMOS Compatible<br>APPLICATIONS<br>Low Signature Radar<br>Medical Imaging<br>Communications Instrumentation<br>Instrumentation<br>Antenna Array Processing

FUNCTIONAL BLOCK DIAGRAM


## PRODUCT HIGHLIGHTS

1. Guaranteed sample rate of 80 MSPS.
2. Input signal conditioning with optimized noise performance.
3. Fully tested and guaranteed performance.

## AD10678-SPECIFICATIONS

 otherwise noted.)

| Parameter | Test Level | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RESOLUTION <br> Offset Error <br> Gain Error Differential Nonlinearity (DNL) Integral Nonlinearity (INL) | $\begin{aligned} & \mathrm{I} \\ & \mathrm{I} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ | $\begin{aligned} & -0.30 \\ & -7 \end{aligned}$ | $\begin{aligned} & 16 \\ & +0.12 \\ & \pm 0.7 \\ & \pm 4 \end{aligned}$ | $\begin{aligned} & +0.30 \\ & +7 \end{aligned}$ | Bits <br> \%FS <br> \%FS <br> LSB <br> LSB |
| TEMPERATURE DRIFT <br> Offset Error <br> Gain Error | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & 13 \\ & 200 \end{aligned}$ |  | $\begin{aligned} & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \end{aligned}$ |
| POWER SUPPLY REJECTION (PSRR) | V |  | 60 |  | dB |
| ANALOG INPUTS (AIN, $\overline{\text { AIN }}{ }^{1}$ Differential Input Voltage Range Differential Input Resistance Differential Input Capacitance Input Bandwidth VSWR ${ }^{2}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{IV} \\ & \mathrm{~V} \end{aligned}$ | 0.40 | $\begin{aligned} & 2.15 \\ & 50 \\ & 2.5 \\ & \\ & 1.04: 1 \end{aligned}$ | 220 | $\begin{aligned} & \text { V p-p } \\ & \Omega \\ & \mathrm{nF} \\ & \mathrm{MHz} \\ & \text { Ratio } \end{aligned}$ |
| POWER SUPPLY ${ }^{3}$ <br> Supply Current $\mathrm{IAV}_{\mathrm{CC}}\left(\mathrm{AV}_{\mathrm{CC}}=5.0 \mathrm{~V}\right)$ <br> $\mathrm{IEV}_{\mathrm{CC}}\left(\mathrm{EV}_{\mathrm{CC}}=3.3 \mathrm{~V}\right)$ <br> $\mathrm{IV}_{\mathrm{DD}}\left(\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}\right)$ <br> Total Power Dissipation ${ }^{4}$ | I |  | $\begin{aligned} & 0.95 \\ & 0.15 \\ & 0.49 \\ & 6.86 \end{aligned}$ | $\begin{aligned} & 1.1 \\ & 0.2 \\ & 0.625 \\ & 8.0 \end{aligned}$ | $\begin{aligned} & \mathrm{A} \\ & \mathrm{~A} \\ & \mathrm{~A} \\ & \mathrm{~W} \end{aligned}$ |

NOTES
${ }^{1}$ Measurement includes the recommended interface connector.
${ }^{2}$ Input VSWR, see TPC 8.
${ }^{3}$ Supply voltages should remain stable within $\pm 5 \%$ for normal operation.
${ }^{4}$ Power dissipation measures with encode at rated speed and -1 dBFS analog input at midband.
Specifications subject to change without notice.
DIGITAL SPECIFICATIONS $\begin{gathered}\left(A V_{c C}=5 \mathrm{~V}, E \mathrm{~V}_{C c}=3.3 \mathrm{~V}, \mathrm{~V}_{D D}=3.3 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \text {, Differential Encode }=80 \mathrm{MSPS}, \mathrm{C}_{\text {LOAD }} \leq 10 \mathrm{pF} \text {, }\right. \\ \text { unlerwise noted. })\end{gathered}$

| Parameter | Test Level | Min | Typ Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| ENCODE INPUTS (ENCODE, $\overline{\text { ENCODE }})$ <br> Differential Input Voltage Range <br> Differential Input Resistance <br> Differential Input Capacitance | $\begin{aligned} & \text { IV } \\ & \text { V } \\ & \text { V } \end{aligned}$ | 0.4 | $\begin{aligned} & 100 \\ & 160 \end{aligned}$ | $\begin{aligned} & \text { V p-p } \\ & \Omega \\ & \mathrm{pF} \end{aligned}$ |
| LOGIC OUTPUTS (D15-D0) <br> Logic Compatibility <br> Logic 1 Voltage- $\mathrm{I}_{\text {LOAD }} \leq 100 \mathrm{~mA}$ <br> Logic 0 Voltage- $\mathrm{I}_{\text {LOAD }} \leq 100 \mathrm{~mA}$ <br> Output Coding <br> Series Output Resistance-per Bit | $\begin{aligned} & \text { IV } \\ & \text { IV } \end{aligned}$ |  | CMOS $0.9 \times \mathrm{V}_{\mathrm{DD}}$ <br> 0.4 <br> True Binary $120$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \Omega \end{aligned}$ |

Specifications subject to change without notice.
SWITCHING SPECIFICATIONS
$\left(\mathrm{AV}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{EV}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=3.3 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right.$, Differential Encode $=80 \mathrm{MSPS}, \mathrm{C}_{\mathrm{LOAD}} \leq 10 \mathrm{pF}$, unless otherwise noted.)

| Parameter | Test Level | Min | Typ | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Maximum Conversion Rate | I | 80 |  |  | MSPS |
| Minimum Conversion Rate | IV |  | 30 | MSPS |  |
| Duty Cycle | IV | 40 | 60 | $\%$ |  |

[^0]

| Parameter |  | Test Level | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SNR ${ }^{1}$ |  |  |  |  |  |  |
| Analog Input ( ) -6 dBFS | 2.5 MHz | I | 77.5 | 80.5 |  | dBFS |
|  | 10 MHz | I | 77.5 | 80.5 |  | dBFS |
|  | 30 MHz | I | 77 | 80.2 |  | dBFS |
|  | 70 MHz | I | 76 | 78 |  | dBFS |
| SINAD ${ }^{2}$ |  |  |  |  |  |  |
| Analog Input | 2.5 MHz | I | 77.2 | 80.3 |  | dBFS |
| @ -6 dBFS | 10 MHz | I | 77.2 | 80.3 |  | dBFS |
|  | 30 MHz | I | 76.6 | 79.7 |  | dBFS |
|  | 70 MHz | I | 74.7 | 77.4 |  | dBFS |
| SPURIOUS FREE DYNAMIC RANGE (SFDR) ${ }^{3}$ |  |  |  |  |  |  |
| Analog Input | 2.5 MHz | I | 88 | 97.2 |  | dBFS |
| @ -6 dBFS | 10 MHz | I | 88 | 97.2 |  | dBFS |
|  | 30 MHz | I | 84 | 94.2 |  | dBFS |
|  | 70 MHz | I | 81 | 91.7 |  | dBFS |
| TWO-TONE ${ }^{4}$ |  |  |  |  |  |  |
| Analog Input |  |  |  |  |  |  |
| @ -7 dBFS- |  | v |  | 96 |  | dBFS |
| $\mathrm{f} 1=10 \mathrm{MHz}$ |  |  |  |  |  |  |
| $\mathrm{f} 2=12 \mathrm{MHz}$ |  |  |  |  |  |  |
| $\mathrm{fl}=70 \mathrm{MHz}$ |  | V |  | 84 |  | dBFS |
| $\mathrm{f} 2=72 \mathrm{MHz}$ |  |  |  |  |  |  |

## NOTES

${ }^{1}$ Analog Input signal power at -1 dBFS ; signal-to-noise (SNR) is the ratio of signal level to total noise (first five harmonics removed).
Encode $=80$ MSPS. SNR is reported in dBFS, related back to converter full scale.
${ }^{2}$ Analog Input signal power at -1 dBFS ; signal-to-noise and distortion (SINAD) is the ratio of signal level to total noise + harmonics.
Encode $=80$ MSPS. SINAD is reported in dBFS, related back to converter full scale.
${ }^{3}$ Analog Input signal equal -1 dBFS ; SFDR is the ratio of converter full scale to worst spur.
${ }^{4}$ Both input tones at -7 dBFS ; two tone intermodulation distortion (IMD) rejection is the ratio of either tone to the worst third order intermodulation product.
Specifications subject to change without notice.


| Parameter | Test Level | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ENCODE INPUTS PARAMETERS <br> Encode Period @ 80 MSPS-t $t_{E N C}$ <br> Encode Pulsewidth High @ 80 MSPS- $\mathrm{t}_{\text {ENCH }}$ Encode Pulsewidth Low @ 80 MSPS- $t_{\text {ENCL }}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & 12.5 \\ & 6.25 \\ & 6.25 \end{aligned}$ |  | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \\ & \mathrm{~ns} \end{aligned}$ |
| ENCODE/DATA (D15:0) <br> Propagation Delay- $t_{\text {PDH }}$ Valid Time- t $_{\text {PDL }}$ |  |  | $\begin{aligned} & 6.7 \\ & 7.3 \end{aligned}$ |  | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| ENCODE/DATA READY* <br> Encode Rising to Data Ready Falling- $t_{\text {DR_F }}$ Encode Rising to Data Ready Rising- $t_{D R \_R}$ |  |  | $\begin{aligned} & 12.6 \\ & 6.4 \end{aligned}$ |  | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| DATA READY/DATA* Data Ready to Data (Hold Time) - $\mathrm{t}_{\mathrm{H} \_\mathrm{DR}}$ Data Ready to Data (Setup Time)- $\mathrm{t}_{\mathrm{S}_{-} \text {DR }}$ |  |  | $\begin{aligned} & 10 \\ & 1 \end{aligned}$ |  | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |
| APERTURE DELAY- $\mathrm{t}_{\text {A }}$ | V |  | 480 |  | ps |
| APERTURE UNCERTAINTY (JITTER)- $\mathrm{t}_{\mathrm{J}}$ | V |  | 500 |  | fs rms |
| PIPELINE DELAYS | V |  | 10 |  | Cycles |

*Duty Cycle $=50 \%$.
Specifications subject to change without notice.

## AD10678

ABSOLUTE MAXIMUM RATINGS*
AV ${ }_{\text {CC }}$ to AGND . . . . . . . . . . . . . . . . . . . . . . . . . . . . 0 V to 7 V

$\mathrm{V}_{\mathrm{DD}}$ to DGND . . . . . . . . . . . . . . . . . . . . . . . . -0.5 V to +3.8 V
Analog Input Voltage . . . . . . . . . . . . . . . . . . . . . . . 0 V to AV ${ }_{\mathrm{CC}}$
Analog Input Current . . . . . . . . . . . . . . . . . . . . . . . . . . 25 mA
Encode Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . 0 V to 5 V
Digital Output Voltage . . . . . . . . . . . . . . . . . . . -0.5 V to VDD
Maximum Junction Temperature . . . . . . . . . . . . . . . . $150^{\circ} \mathrm{C}$
Storage Temperature Range Ambient . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Maximum Operating Temperature Ambient . . . . . . . . . $92^{\circ} \mathrm{C}$
*Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## OPERATING RANGE*

Operating Ambient Temperature Range . . . . . . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
*See Thermal Considerations section.

## EXPLANATION OF TEST LEVELS

I $100 \%$ production tested.
II $100 \%$ production tested at $25^{\circ} \mathrm{C}$ and sample tested at specified temperatures.
III Sample tested only.
IV Parameter is guaranteed by design and characterization testing.
V Parameter is a typical value only.
VI $100 \%$ production tested at $25^{\circ} \mathrm{C}$; guaranteed by design and characterization testing for industrial temperature range; $100 \%$ production tested at temperature extremes for military devices.

Table I. Output Coding (True Binary)

| Code | AIN (V) | Digital Output |
| :--- | :--- | :--- |
| 65535 | +1.1 | 1111111111111110 |
| $\cdot$ | $\cdot$ | $\cdot$ |
| $\cdot$ | $\cdot$ | $\cdot$ |
| 32768 | 0 | 1000000000000000 |
| 32767 | -0.000034 | 0111111111111111 |
| $\cdot$ | $\cdot$ | $\cdot$ |
| $\cdot$ | $\cdot$ | $\cdot$ |
| $\cdot$ | - | 0000000000000000 |

ORDERING GUIDE

| Model | Temperature Range | Package Option |
| :--- | :--- | :--- |
| AD10678BWS | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ (Ambient) | $2.2^{\prime \prime} \times 2.8^{\prime \prime}$ |
| AD10678/PCB | $25^{\circ} \mathrm{C}$ | Evaluation Board |

## Test Circuits



Figure 1. Timing Diagram


Figure 2. Analog Input Stage


Figure 3. Equivalent Encode Input


Figure 4. Digital Output Stage


Figure 5. Data-Ready Output

INTERFACES 1 AND 2: DIGITAL PIN FUNCTION DESCRIPTIONS

| P1: Pin Number | Mnemonic | Function | P2: Pin <br> Number | Mnemonic | Function |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | DGND | Digital Ground | 1 | DGND | Digital Ground |
| 2 | DGND | Digital Ground | 2 | DGND | Digital Ground |
| 3 | $\mathrm{D}_{\text {OUT }} 15$ | Data Bit Output | 3 | +3.3VD | Digital Voltage |
| 4 | NC | No Connection | 4 | $\mathrm{D}_{\text {OUT }} 0$ | Data Bit Output |
| 5 | $\mathrm{D}_{\text {OUT }} 14$ | Data Bit Output | 5 | +3.3VD | Digital Voltage |
| 6 | DGND | Digital Ground | 6 | D ${ }_{\text {OUT }} 1$ | Data Bit Output |
| 7 | $\mathrm{D}_{\text {OUT }} 13$ | Data Bit Output | 7 | +3.3VD | Digital Voltage |
| 8 | NC | No Connection | 8 | $\mathrm{D}_{\text {OUT }}{ }^{2}$ | Data Bit Output |
| 9 | $\mathrm{D}_{\text {OUT }} 12$ | Data Bit Output | 9 | DGND | Digital Ground |
| 10 | DGND | Digital Ground | 10 | $\mathrm{D}_{\text {OUT }}{ }^{3}$ | Data Bit Output |
| 11 | $\mathrm{D}_{\text {OUT }} 11$ | Data Bit Output | 11 | DGND | Digital Ground |
| 12 | NC | No Connection | 12 | $\mathrm{D}_{\text {OUT }} 4$ | Data Bit Output |
| 13 | $\mathrm{D}_{\text {OUT }} 10$ | Data Bit Output | 13 | DGND | Digital Ground |
| 14 | DGND | Digital Ground | 14 | $\mathrm{D}_{\text {OUT }} 5$ | Data Bit Output |
| 15 | $\mathrm{D}_{\text {OUT }}{ }^{\text {9 }}$ | Data Bit Output | 15 | DGND | Digital Ground |
| 16 | NC | No Connection | 16 | $\mathrm{D}_{\text {OUT }} 6$ | Data Bit Output |
| 17 | $\mathrm{D}_{\text {OuT }} 8$ | Data Bit Output | 17 | +3.3VD | Digital Voltage |
| 18 | DGND | Digital Ground | 18 | $\mathrm{D}_{\text {OUT }} 7$ | Data Bit Output |
| 19 | DGND | Digital Ground | 19 | +3.3VD | Digital Voltage |
| 20 | DRY | Data Ready Output | 20 | DGND | Digital Ground |

INTERFACE 3: ANALOG PIN FUNCTION DESCRIPTIONS

| P3: Pin <br> Number | Mnemonic | Function |
| :--- | :--- | :--- |
| 1 | +3.3VE | Encode Voltage |
| 2 | +5.0VA | Analog Voltage |
| 3 | +3.3VE | Encode Voltage |
| 4 | +5.0VA | Analog Voltage |
| 5 | AGND | Analog Ground |
| 6 | +5.0VA | Analog Voltage |
| 7 | AGND | Analog Ground |
| 8 | +5.0VA | Analog Voltage |
| 9 | AGND | Analog Ground |
| 10 | AGND | Analog Ground |
| 11 | AGND | Analog Ground |
| 12 | AIN | Analog Input |
| 13 | AGND | Analog Ground |
| 14 | AIN | Analog Input |
| 15 | ENCODE | Encode Input |
| 16 | AGND | Analog Ground |
| 17 | ENCODE | Encode Input |
| 18 | AGND | Analog Ground |
| 19 | AGND | Analog Ground |
| 20 | AGND | Analog Ground |

## TOP VIEW OF INTERFACE PCB ASSEMBLY

Dimensions shown in inches
Tolerances:
$0 . \mathrm{xx}= \pm 10 \mathrm{mils}$
$0 . \mathrm{xxx}= \pm 5 \mathrm{mils}$


INTERFACE NOTES:
SUGGESTED INTERFACE MANUFACTURER: SAMTEC
INTERFACE PART NUMBERS FOR P1-P3: FSI-110-03-G-D-AD-K-TR (20-PIN)
HOLES 1-4 ACCOMMODATE 2-56 THREADED HARDWARE. USE FOUR 2-56 NUTS FOR SECURING
THE PART TO INTERFACE PCB.
MANUFACTURER: BUILDING FASTENERS
PART NUMBER: HNSS256
DIGIKEY \#: H723-ND
Figure 6. Header Interface Dimensions (Inches)

## AD10678-Typical Performance Characteristics



TPC 1. Single-Tone at 2.5 MHz


TPC 2. Single-Tone at 10 MHz


TPC 3. Single-Tone at 32 MHz


TPC 4. Single-Tone at 70 MHz


TPC 5. Two-Tone at 10.1 MHz and 12.1 MHz


TPC 6. Two-Tone at 70 MHz and 72 MHz


TPC 7. Gain Flatness


TPC 8. Analog Input VSWR


TPC 9. SFDR and SNR vs. Analog Input Level


TPC 10. SFDR and SNR vs. Analog Input Frequency

## AD10678

## DEFINITION OF SPECIFICATIONS

## Analog Bandwidth

The analog input frequency at which the spectral power of the fundamental frequency (as determined by the FFT analysis) is reduced by 3 dB .

## Aperture Delay

The delay between the $50 \%$ point on the rising edge of the ENCODE command and the instant at which the analog input is sampled.

## Aperture Uncertainty (Jitter)

The sample-to-sample variation in aperture delay.

## Differential Nonlinearity

The deviation of any code from an ideal 1 LSB step.

## Integral Nonlinearity

The deviation of the transfer function from a reference line measured in fractions of 1 LSB using a "best straight line" determined by a least square curve fit.

## Encode Pulsewidth/Duty Cycle

Pulsewidth high is the minimum amount of time that the ENCODE pulse should be left in Logic 1 state to achieve rated performance; pulsewidth low is the minimum time that the ENCODE pulse should be left in low state. At a given clock rate, these specifications define an acceptable Encode duty cycle.

## Harmonic Distortion

The ratio of the rms signal amplitude to the rms value of the worst harmonic component.

## Minimum Conversion Rate

The encode rate at which the SNR of the lowest analog signal frequency drops by no more than 3 dB below the guaranteed limit.

## Maximum Conversion Rate

The encode rate at which parametric testing is performed.

## Output Propagation Delay

The delay between the $50 \%$ point of the rising edge of the ENCODE command and the time when all output data bits are within valid logic levels.

## Power Supply Rejection Ratio

The ratio of a change in output offset voltage to a change in power supply voltage.

## Signal-to-Noise-and-Distortion (SINAD)

The ratio of the rms signal amplitude (set at 1 dB below full scale) to the rms value of the sum of all other spectral components, excluding the first five harmonics and dc. May be reported in dBc (i.e., degrades as signal level is lowered) or in dBFS (always related back to converter full scale).

## Signal-to-Noise Ratio (without Harmonics)

The ratio of the rms signal amplitude (set at 1 dB below full scale) to the rms value of the sum of all other spectral components, excluding the first five harmonics and dc. May be reported in dBc (i.e., degrades as signal level is lowered) or in dBFS (always related back to converter full scale).

## Spurious-Free Dynamic Range

The ratio of the rms signal amplitude to the rms value of the peak spurious spectral component. The peak spurious component may or may not be a harmonic. May be reported in dBc (i.e., degrades as signal level is lowered) or in dBFS (always related back to converter full scale).

## Two-Tone Intermodulation Distortion Rejection

The ratio of the rms value of either input tone to the rms value of the worst third-order intermodulation product; reported in dBc .

## Voltage Standing-Wave Ratio (VSWR)

The ratio of the amplitude of the elective field at a voltage maximum to that at an adjacent voltage minimum.

## THERMAL CONSIDERATIONS

Due to the high power nature of the part, it is critical that the following thermal conditions be met for the part to perform to data sheet specifications. This also ensures that the maximum junction temperature $\left(150^{\circ} \mathrm{C}\right)$ is not exceeded.

- Operation temperature $\left(\mathrm{t}_{\mathrm{A}}\right)$ must be within $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.
- All mounting standoffs should be fastened to the interface PCB assembly with 2-56 nuts. This ensures good thermal paths as well as excellent ground points.
- The unit rises to $\sim 72^{\circ} \mathrm{C}\left(\mathrm{t}_{\mathrm{C}}\right)$ on the heat sink in still air ( 0 linear feet per minute (LFM)). 100 linear feet perminute (LFM) in either direction across the heat sink is the minimum recommended air flow. See Figure 7.


Figure 7. Temperature (Case) vs. Air Flow (Ambient)

## THEORY OF OPERATION

The AD10678 employs four parallel, high speed analog-todigital converters in a correlation technique, which improves the dynamic range of the ADCs. The technique consists of summing the parallel outputs of the four converters to reduce the uncorrelated noise introduced by the individual converters. Signals processed through the high speed adder are correlated and summed coherently. Noise is not correlated and sums on an rms basis.

The four high speed, analog-to-digital converters employ a three-stage subrange architecture. The AD10678 provides complementary analog input pins, AIN and AIN. Each analog input is centered around 2.4 V and should swing $\pm 0.55 \mathrm{~V}$ around the reference. Since AIN and $\overline{\text { AIN }}$ are 180 degrees out of phase, the differential analog input signal is 2.15 V p-p.
The analog input is designed to meet a $50 \Omega$ input impedance for ease of interface to commercially available cables, filters, and drivers, among others.
The AD10678 encode inputs are ac-coupled to a PECL differential receiver/driver. The output of the receiver/driver provides a clock source for a 1:5 PECL Clock driver and a PECL to TTL translator. The 1:5 PECL Clock driver provides the differential encode signal for each of the four high speed analog-to-digital converters. The PECL to TTL translator is used to provide a clock source for the Complex Programmable Logic Device (CPLD).
The digital outputs from the four ADCs drive $120 \Omega$ series output terminators and are applied to the CPLD for post-processing. The digital outputs are added together in the Complex Programmable Logic Device through a ripple-carry adder, which provides the 16-bit data output. The AD10678 provides valid data following 10 pipeline delays. The result is a 16 -bit parallel digital CMOS compatible word coded as true binary.

## INPUT STAGE

The user is provided with a single to differential transformer coupled input. The input impedance is $50 \Omega$ and requires a $2.15 \mathrm{~V} \mathrm{p}-\mathrm{p}$ input level to achieve full scale.

## ENCODING THE AD10678

The AD10678 encode signal must be a high quality, low phase noise source to prevent performance degradation. The clock input must be treated as an analog input signal because aperture jitter may affect dynamic performance. For optimum performance, the AD10678 must be clocked differentially.

## OUTPUT LOADING

Care should be taken when designing the data receivers for the AD10678. The Complex Programmable Logic Device 16-bit
outputs drive $120 \Omega$ series resistors to limit the amount of current that can flow into the output stage. To minimize capacitive loading, there should only be one gate on each of the output pins. A typical CMOS gate combined with the PCB trace has a load of approximately 10 pF . It should be noted that extra capacitive loading increases output timing and invalidates timing specifications. Digital output timing is guaranteed with 10 pF .

## ANALOG AND DIGITAL POWER SUPPLIES

Care must be taken when selecting a power source. Linear supplies are recommended. Switching supplies tend to have radiated components that may be coupled into the ADCs. The AD10678 features separate analog and digital supply and ground currents, helping to minimize digital corruption of sensitive analog signals.

The 3.3 V supply provides power for the output section of the ADCs, the CPLD, and the clock circuit. The +3.3 VE supply provides power to the clock distribution circuit. The +3.3 VD supply provides power to digital output section of the ADCs, the PCEL to TTL translator, and the CPLD. Separate $+3.3 V E$ and +3.3 VD supplies are utilized to prevent modulation of the clock signal with digital noise. The 5 V supply provides power to the analog sections of the ADCs. Decoupling capacitors are strategically placed throughout the circuit to provide low impedance noise shunts to ground. The +5 VA supply (analog power) should be decoupled to AGND (analog ground) and +3.3VD (digital power) should be decoupled to DGND (digital ground). The +3.3 VE supply (analog power) should be decoupled to AGND. The evaluation board schematic and layout data provide a typical PCB implementation of the AD10678.

## ANALOG AND DIGITAL GROUNDING

Although the AD10678 provides separate analog and digital ground pins, the device should be treated as an analog component. Proper grounding is essential in high speed, high resolution systems. Multilayer printed circuit boards are recommended to provide optimal grounding and power distribution. The use of power and ground planes provides distinct advantages. Power and ground planes minimize the loop area encompassed by a signal and its return path, minimize the impedance associated with power and ground paths, and provide a distributed capacitor formed by the power plane printed circuit board material and ground plane. The AD10678 unit is provided with four metal standoffs (see Figure 6). MH2 is located in the center of the unit and MH1 is located directly below analog header P3. Both of these standoffs are tied to analog ground and should be connected accordingly on the next level assembly for optimum performance. The two standoffs located near P1 and P2 (MH3 and MH4) are tied to digital ground and should be connected accordingly on the next-level assembly.

## AD10678

## OTHER NOTES

The circuit is configured on a $2.2^{\prime \prime} \times 2.8^{\prime \prime}$ laminate board with three sets of connector interface pads. The pads are configured in such a way that easy "keying" is provided to the user. The pads are made for low profile applications and have a total height of $0.12^{\prime \prime}$ after mating. The part numbers for the header mates are provided in Figure 6. All pins of the analog and digital sections are described in the Pin Function Description tables.

## EVALUATION BOARD

The AD10678 evaluation board provides an easy way to test the 16-bit 80 MSPS A/D converter. The board requires a clock source, an analog input signal, two 3.3 V power supplies, and a

5 V power supply. The clock source is buffered on the board to provide the clock for the AD10678, a latch, and a data ready signal. To use the AD10678 data ready output to clock the buffer memory, remove $\mathrm{R} 24(0.0 \Omega)$ and install a $0.0 \Omega$ resistor at R31 (DNI). The ADC digital outputs are latched on board by a 74LCX16374. The digital outputs and output clock are available on a 40-pin connector J1. Power is supplied to the board via uninsulated metal banana jacks.
The analog input is connected via an SMA connector AIN. The analog input section provides for a single-ended input option or a differential input option. The board is shipped in a single-ended analog input option. Removing a ground tie at E17 converts the circuit to a differential analog input configuration.

## PCB Bill of Material

| Item | Quantity | Reference Designator | Description |
| :---: | :---: | :---: | :---: |
| 1 | 1 | J1 | Connector, 40-Position Header, Male Straight |
| 2 | 1 | U1 | IC, LV 16-Bit D-Type Flip-Flop with 5 V Tolerant I/O |
| 3 | 3 | L1-L3 | Common-Mode Surface-Mount Ferrite Bead $20 \Omega$ |
| 4 | 3 | J11-J13 | Connector, 1 mm Single Element Interface |
| 5 | 6 | P1, P2, P8-P10, P12 | Uninsulated BANANA JACK All Metal |
| 6 | 2 | U5, U6 | IC, 3.3 V/5 V ECL Differential Receiver/Driver |
| 7 | 1 | U7 | IC, 3.3 V Dual Differential LVPECL to LVTTL Translator |
| 8 | 1 | R24 | RES $0.0 \Omega 1 / 10 \mathrm{~W} 5 \% 0805$ SMD |
| 9 | 19 | R0-R16, R20, R23 | RES $51.1 \Omega 1 / 10 \mathrm{~W} 1 \% 0805$ SMD |
| 10 | 1 | R17 | RES $18.2 \mathrm{k} \Omega 1 / 10 \mathrm{~W} 1 \% 0805$ SMD |
| 11 | 4 | R18, R19, R21, R22 | RES $100 \Omega 1 / 10 \mathrm{~W} 1 \% 0805$ SMD |
| 12 | 17 | $\begin{aligned} & \mathrm{C} 1, \mathrm{C} 10-\mathrm{C} 13, \mathrm{C} 16-\mathrm{C} 18, \\ & \mathrm{C} 23-\mathrm{C} 26, \mathrm{C} 29-\mathrm{C} 32 \end{aligned}$ | CAP $0.1 \mu \mathrm{~F} 16 \mathrm{~V}$ CERAMIC X7R 0805 |
| 13 | 6 | C8, C9, C4, C15, C27, C33 | CAP $10 \mu \mathrm{~F} 10 \mathrm{~V}$ CERAMIC Y5V 1206 |
| 14 | 4 | J2, J3, J5, J6 | CONNECTOR, SMA JACK 200 Mil STR GOLD |
| 15 | 1 | A1 | ASSEMBLY, AD10678BWS |
| 16 | 1 | AD106xx Evaluation Board | GS04483 (PCB) |



Figure 8. Evaluation Board Schematic


Figure 9a. Evaluation Board Mechanical Layout Top View


Figure 9b. Evaluation Board Mechanical Layout Bottom View


Figure 9c. Evaluation Board Top Layer Copper


Figure 9d. Evaluation Board Second Layer Copper


Figure 9e. Evaluation Board Third Layer Copper


Figure 9f. Evaluation Board Bottom Layer Copper

## OUTLINE DIMENSIONS

Dimensions shown in inches
Tolerances:
$0 . \mathrm{xx}= \pm 10 \mathrm{mils}$
$0 . \mathrm{xxx}= \pm 5 \mathrm{mils}$

## Bottom View



## Top View





[^0]:    Specifications subject to change without notice.

